2SD2323

Silicon NPN Triple Diffused

HITACHI

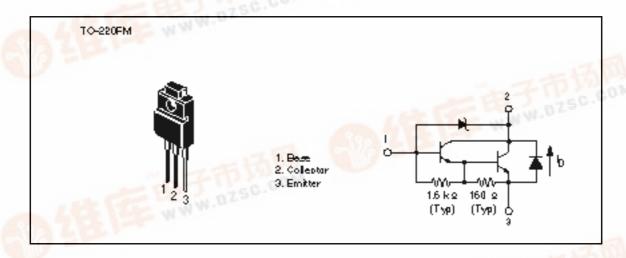
Application

High voltage switching, igniter

Features

- Built-in High voltage zener diode (300 V)
- · High speed switching

Outline





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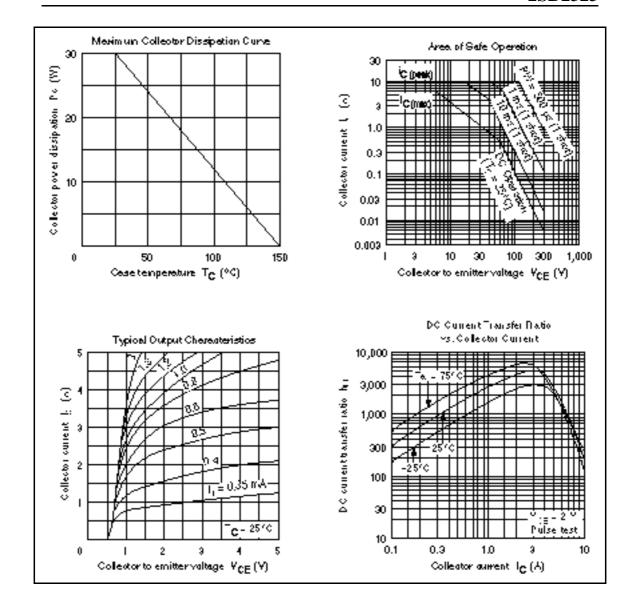
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Rating	Unit
Collector to base voltage	V_{CBO}	300	V
Collector to emitter voltage	V _{CEO}	300	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I _c	6	A
Diode current	l _D *1	6	A
Collector peak current	I _{C(peak)}	10	A
Collector power dissipation	P _c *1	30	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

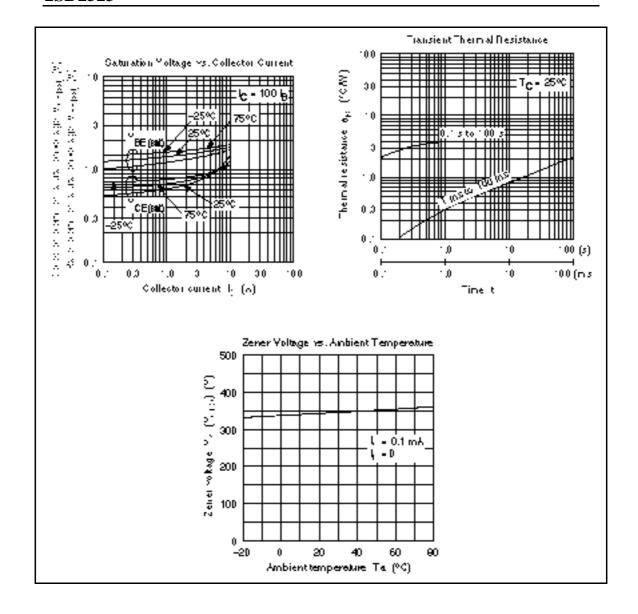
Note: 1. Value at $T_c = 25$ °C.

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\text{(BR)CBO}}$	300	_	420	V	$I_{\rm C} = 0.1 \text{ mA}, I_{\rm E} = 0$
Collector to emitter sustain voltage	$V_{\text{CEO(SUS)}}$	300	_	_	V	$I_{C} = 3 \text{ A}, R_{BE} = , L = 10 \text{ mH}$
Emitter to base breakdown voltage	$V_{\text{(BR)EBO}}$	7	_	_	V	$I_{E} = 50 \text{ mA}, I_{C} = 0$
Collector cutoff current	I _{CEO}	_	_	100	μΑ	$V_{CE} = 300 \text{ V}, R_{BE} =$
DC current transfer ratio	h _{FE}	500	_	_		$V_{CE} = 2 \text{ V}, I_{C} = 4 \text{ A}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.5	V	$I_C = 4 \text{ A}, I_B = 40 \text{ mA}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	_	2.0	V	$I_{\rm C} = 4 \text{ A}, I_{\rm B} = 40 \text{ mA}$
Emitter to collector forward voltage	V_{ECF}	_	_	3.5	V	I _F = 6 A
Turn on time	t _{on}	_	1.2	_	μs	$I_{c} = 4 \text{ A}, V_{cc} = 20 \text{ V}$
Storage time	t_{stg}	_	8.0	_		$I_{B1} = -I_{B2} = 40 \text{ mA}$
Fall time	t _f	_	8.0	_		



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